HD33878
SOLID STATE HIGH POWER AMPLIFIER

FEATURES

Class A/AB linear GaN design
Instantaneous ultra-wide bandwidth
Suitable for all single channel modulation standards
Small form factor and light weigh
Built-in protection circuits
High reliability and ruggedness

ELECTRICAL SPECIFICATIONS

Parameter	Specification	Notes
Operating Frequency Range	0.6 - 6.0 GHz	
Power Output Psat	15 Watt Min	CW
Output Power @ P1dB	10 Watt Min	
Power Gain	42 dB Min	
Power Gain Flatness	4.0 dB p-p Max	Constant input power
Input Return Loss	10 dB Min	Relative to 50 Ohm
2-Tone Intermodulation (IMD)	-30 dBc Typ	30dBm/Tone, Δ = 1MHz
Harmonics 2nd / 3rd	<-15 dBc / -20 dBc Typ	-10dBc Max 0.7-1.5GHz
Spurious	-60 dBc Max	Non-harmonics
Operating Voltage	28 - 30 VDC Nom	
Current Consumption	3.5 Amp Max	At rated Pout
Max Input Power Protection	+8 dBm	<10 Sec without damage
Load VSWR Protection	∞ : 1	<1 minute at rated Pout

ENVIRONMENTAL CHARACTERISTICS

Parameter	Specification	Notes
Operating Case Temperature	-20 to +75 °C	
Storage Temperature	-40 to +85 °C	
Relative Humidity	5 to 95 %	Non-condensation

MECHANICAL SPECIFICATIONS

Parameter	Specification	Notes
Dimensions	157 x 69 x 27 mm	Excluding Connectors
Weight	600 gr.	
RF Connectors In/Out	SMA female	
DC Power / Interface Connector	9-Pin D-Sub	
Cooling	External Heatsink	Forced air required

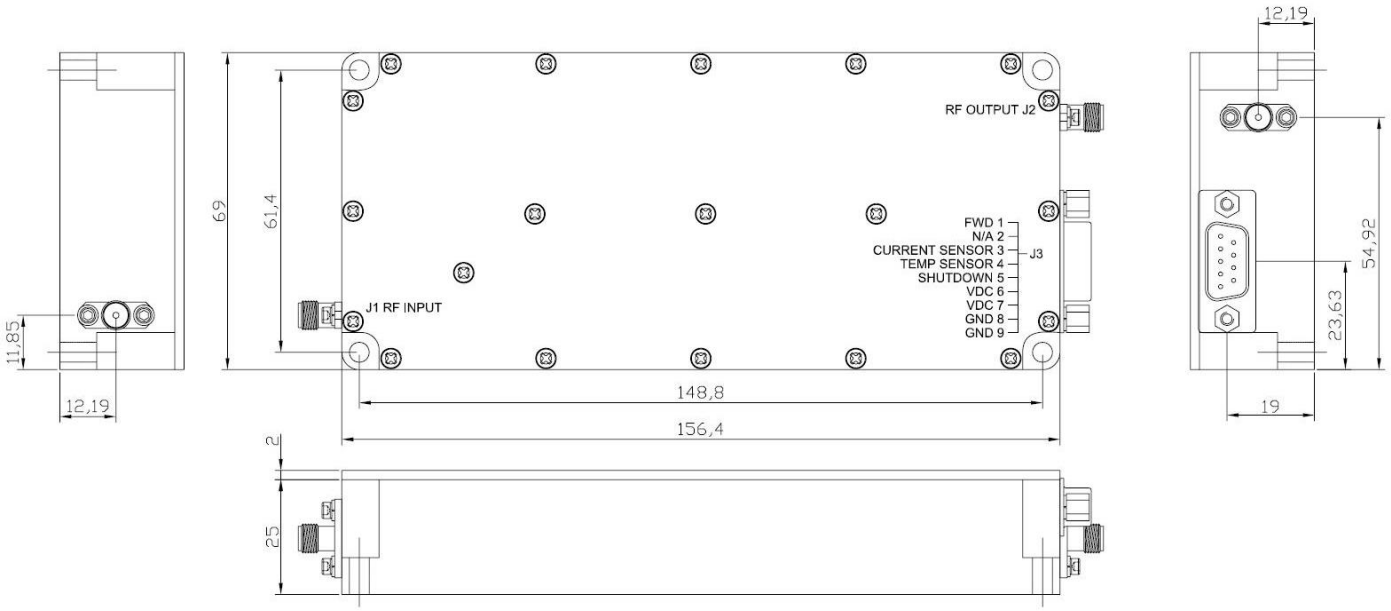
D-SUB CONNECTOR PIN ASSIGNMENT

Pin	Function	Description
1	FWD	N/C
2	REV	N/C
3	CURRENT SENSOR	I_D@20mV/100mA Typ
4	TEMP SENSOR	V_T@10mV/°C + 500mV Typ
5	SHUTDOWN	TTL
6, 7	VDD	28VDC
8, 9	GND	Ground

HD Communications Corp. 338 Jericho Tpke. Ste 387
Syosset, NY 11791
Tel: (631) 588-3877 Email: sales@hdcom.com

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OUTLINE DRAWING



OPTIONAL HEATSINK

(Will be sized for customer application as a direct replacement)

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